

## N-Ch and P-Ch Fast Switching MOSFETs



- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

## Product Summary

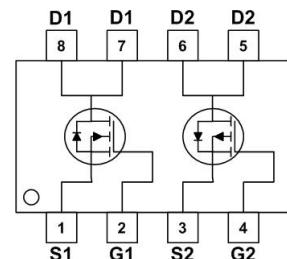
| BVDSS | RDS <sub>ON</sub> | ID    |
|-------|-------------------|-------|
| 40V   | 17mΩ              | 8.5A  |
| -40V  | 39mΩ              | -7.5A |

## Description

The XR4614 is the high performance complementary N-ch and P-ch MOSFETs with high cell density, which provide excellent RDS<sub>ON</sub> and gate charge for most of the synchronous buck converter applications.

The XR4614 meet the RoHS and Green

## SOP8 Pin Configurations

Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise specified)

| Symbol          | Parameter                                       |                           | Max. N-Channel         | Max. P-Channel | Units                     |
|-----------------|---|---------------------------|------------------------|----------------|---------------------------|
| $V_{DSS}$       | Drain-Source Voltage                            |                           | 40                     | -40            | V                         |
| $V_{GSS}$       | Gate-Source Voltage                             |                           | $\pm 20$               | $\pm 20$       | V                         |
| $I_D$           | Continuous Drain Current                        | $T_A = 25^\circ\text{C}$  | 8.5                    | -7.5           | A                         |
|                 |   | $T_A = 100^\circ\text{C}$ | 5.2                    | -3.9           | A                         |
| $I_{DM}$        | Pulsed Drain Current <sup>note1</sup>           |                           | 32                     | -24            | A                         |
| $E_{AS}$        | Single Pulsed Avalanche Energy <sup>note2</sup> |                           | 13                     | 17.6           | mJ                        |
| $P_D$           | Power Dissipation                               | $T_A = 25^\circ\text{C}$  | 2                      | 3.2            | W                         |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient         |                           | 62.5                   | 39             | $^\circ\text{C}/\text{W}$ |
| $T_J, T_{STG}$  | Operating and Storage Temperature Range         |                           | $-55 \text{ to } +150$ |                | $^\circ\text{C}$          |

## N-Ch and P-Ch Fast Switching MOSFETs

N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise specified)

| Symbol  | Parameter  | Test Condition  | Min. | Typ. | Max.      | Units            |
|---|--|---|------|------|-----------|------------------|
| <b>Off Characteristic</b>                                     |  |   |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$                                   | Drain-Source Breakdown Voltage                           | $V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$   | 40   | -    | -         | V                |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current                          | $V_{DS}=40\text{V}$ , $V_{GS}=0\text{V}$  | -    | -    | 1.0       | $\mu\text{A}$    |
| $I_{GSS}$   | Gate to Body Leakage Current                             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 20\text{V}$  | -    | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b>                                     |  |   |      |      |           |                  |
| $V_{GS(\text{th})}$   | Gate Threshold Voltage                                   | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$  | 1.0  | 1.5  | 2.5       | V                |
| $R_{DS(\text{on})}$<br>note3                                  | Static Drain-Source on-Resistance                        | $V_{GS}=10\text{V}$ , $I_D=8\text{A}$   | -    | 17   | 22        | $\text{m}\Omega$ |
|   |  | $V_{GS}=4.5\text{V}$ , $I_D=5\text{A}$  | -    | 25   | 35        | $\text{m}\Omega$ |
| <b>Dynamic Characteristics</b>                                |  |   |      |      |           |                  |
| $C_{iss}$   | Input Capacitance  | $V_{DS}=20\text{V}$ , $V_{GS}=0\text{V}$ ,<br>$f=1.0\text{MHz}$                       | -    | 633  | -         | pF               |
| $C_{oss}$   | Output Capacitance                                       |   | -    | 67   | -         | pF               |
| $C_{rss}$   | Reverse Transfer Capacitance                             |   | -    | 58   | -         | pF               |
| $Q_g$   | Total Gate Charge  | $V_{DS}=20\text{V}$ , $I_D=8\text{A}$ ,<br>$V_{GS}=10\text{V}$                        | -    | 12   | -         | nC               |
| $Q_{gs}$  | Gate-Source Charge                                       |   | -    | 3.2  | -         | nC               |
| $Q_{gd}$  | Gate-Drain("Miller") Charge                              |   | -    | 3.1  | -         | nC               |
| <b>Switching Characteristics</b>                              |  |   |      |      |           |                  |
| $t_{d(on)}$   | Turn-on Delay Time                                       | $V_{DD}= 20\text{V}$ , $R_L = 2.5\Omega$<br>$V_{GS}=10\text{V}$ , $R_{REN} = 3\Omega$ | -    | 4    | -         | ns               |
| $t_r$   | Turn-on Rise Time  |   | -    | 3    | -         | ns               |
| $t_{d(off)}$  | Turn-off Delay Time                                      |   | -    | 15   | -         | ns               |
| $t_f$   | Turn-off Fall Time                                       |   | -    | 2    | -         | ns               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |  |   |      |      |           |                  |
| $I_S$   | Maximum Continuous Drain to Source Diode Forward Current |   | -    | -    | 8.5       | A                |
| $I_{SM}$  | Maximum Pulsed Drain to Source Diode Forward Current     |   | -    | -    | 32        | A                |
| $V_{SD}$  | Drain to Source Diode Forward Voltage                    | $V_{GS}=0\text{V}$ , $I_S= 8\text{A}$   | -    | -    | 1.2       | V                |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{DD}=20\text{V}$ ,  $V_G=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$ ,  $I_{AS}=7.2\text{A}$

$T_J=25^\circ\text{C}$ ,  $V_{DD}=-20\text{V}$ ,  $V_G= -10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$ ,  $I_{AS}=-8.4\text{A}$

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$

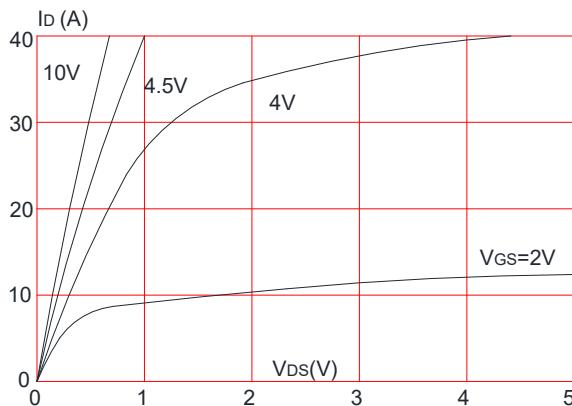
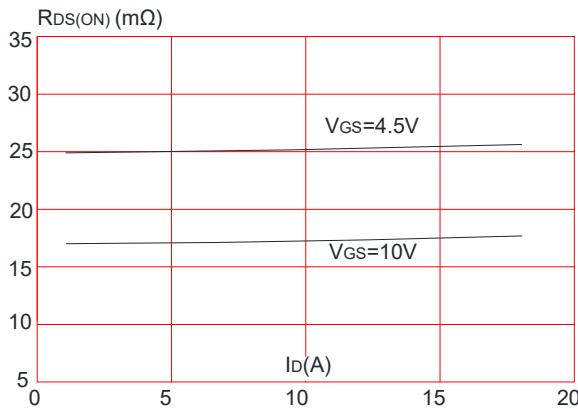
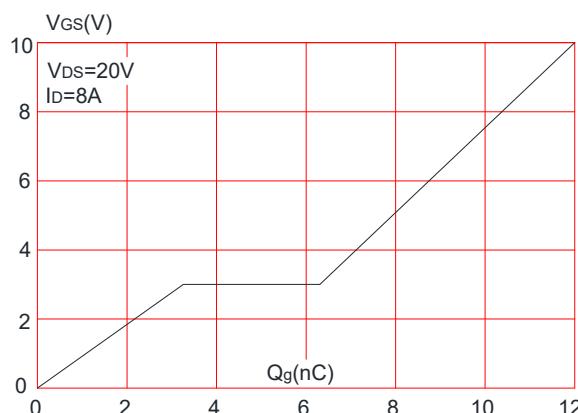
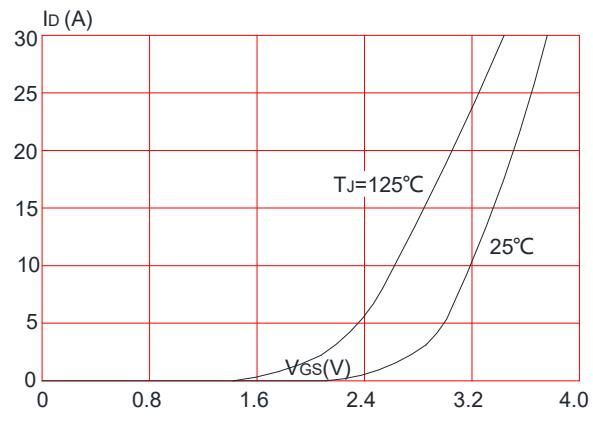
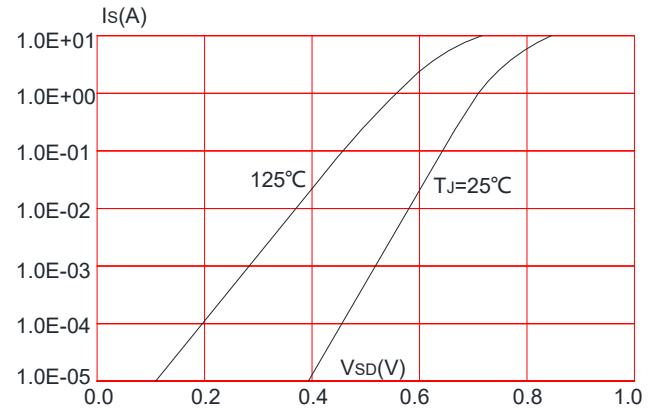
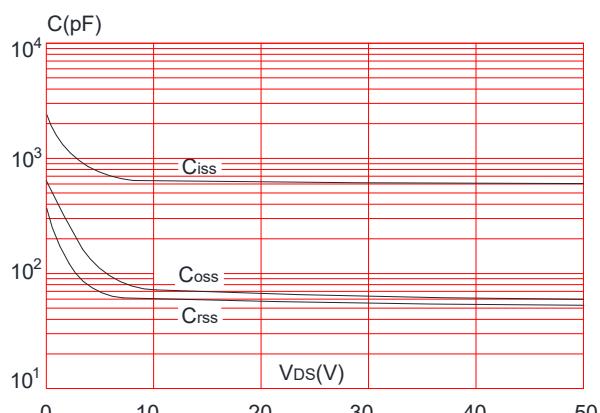
## N-Ch and P-Ch Fast Switching MOSFETs

P-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise specified)

| Symbol  | Parameter  | Test Condition   | Min. | Typ. | Max.      | Units            |
|---|--|--|------|------|-----------|------------------|
| <b>Off Characteristic</b>                                     |  |  |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$                                   | Drain-Source Breakdown Voltage                           | $V_{GS}=0\text{V}$ , $I_D = -250\mu\text{A}$   | -40  | -    | -         | V                |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current                          | $V_{DS} = -40\text{V}$ , $V_{GS}=0\text{V}$  | -    | -    | -1        | $\mu\text{A}$    |
| $I_{GSS}$   | Gate to Body Leakage Current                             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 20\text{V}$   | -    | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b>                                     |  |  |      |      |           |                  |
| $V_{GS(\text{th})}$   | Gate Threshold Voltage                                   | $V_{DS}=V_{GS}$ , $I_D = -250\mu\text{A}$  | -1.0 | -1.6 | -2.5      | V                |
| $R_{DS(\text{on})}$<br>note3                                  | Static Drain-Source on-Resistance                        | $V_{GS} = -10\text{V}$ , $I_D = -6\text{A}$  | -    | 39   | 53        | $\text{m}\Omega$ |
|   |  | $V_{GS} = -4.5\text{V}$ , $I_D = -4\text{A}$   | -    | 58   | 81        |                  |
| <b>Dynamic Characteristics</b>                                |  |  |      |      |           |                  |
| $C_{iss}$   | Input Capacitance  | $V_{DS} = -20\text{V}$ , $V_{GS}=0\text{V}$ ,<br>$f=1.0\text{MHz}$                         | -    | 860  | -         | pF               |
| $C_{oss}$   | Output Capacitance                                       |  | -    | 87   | -         | pF               |
| $C_{rss}$   | Reverse Transfer Capacitance                             |  | -    | 70   | -         | pF               |
| $Q_g$   | Total Gate Charge  | $V_{DS} = -20\text{V}$ , $I_D = -6\text{A}$ ,<br>$V_{GS} = -10\text{V}$                    | -    | 13   | -         | nC               |
| $Q_{gs}$  | Gate-Source Charge                                       |  | -    | 3.8  | -         | nC               |
| $Q_{gd}$  | Gate-Drain("Miller") Charge                              |  | -    | 3.1  | -         | nC               |
| <b>Switching Characteristics</b>                              |  |  |      |      |           |                  |
| $t_{d(on)}$   | Turn-on Delay Time                                       | $V_{DD} = -20\text{V}$ , $R_L = 2.3\Omega$<br>$V_{GS} = -10\text{V}$ , $R_{REN} = 6\Omega$ | -    | 7.5  | -         | ns               |
| $t_r$   | Turn-on Rise Time  |  | -    | 5.5  | -         | ns               |
| $t_{d(off)}$  | Turn-off Delay Time                                      |  | -    | 19   | -         | ns               |
| $t_f$   | Turn-off Fall Time                                       |  | -    | 7    | -         | ns               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |  |  |      |      |           |                  |
| $I_S$   | Maximum Continuous Drain to Source Diode Forward Current | -  | -    | -    | -7.5      | A                |
| $I_{SM}$  | Maximum Pulsed Drain to Source Diode Forward Current     | -  | -    | -    | -24       | A                |
| $V_{SD}$  | Drain to Source Diode Forward Voltage                    | $V_{GS}=0\text{V}$ , $I_S = -6\text{A}$  | -    | -    | -1.2      | V                |

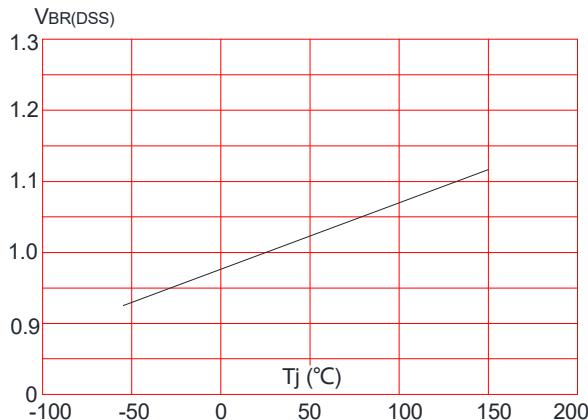
## N-Ch and P-Ch Fast Switching MOSFETs

## Typical Performance Characteristics-N

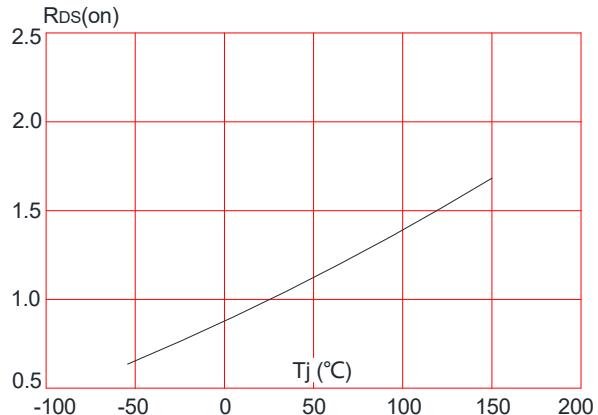
**Figure 1:** Output Characteristics**Figure 3:** On-resistance vs. Drain Current**Figure 5:** Gate Charge Characteristics**Figure 2:** Typical Transfer Characteristics**Figure 4:** Body Diode Characteristics**Figure 6:** Capacitance Characteristics

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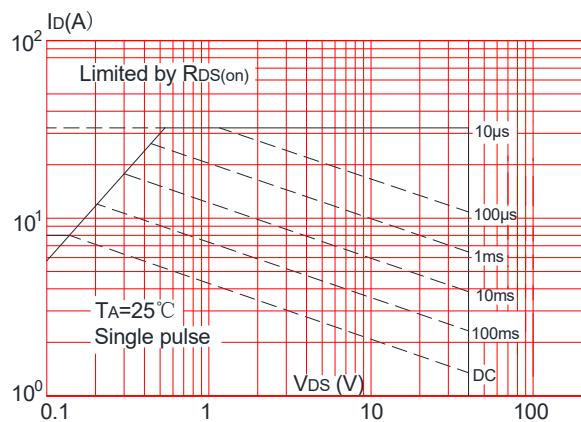
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



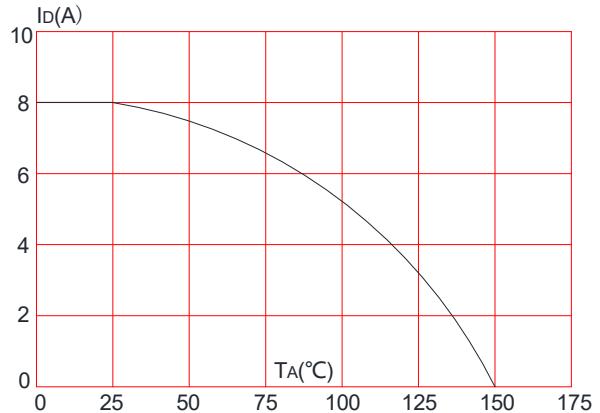
**Figure 8:** Normalized on Resistance vs. Junction Temperature



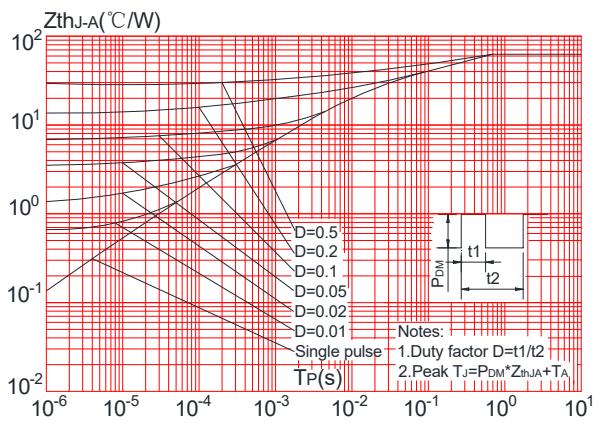
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature

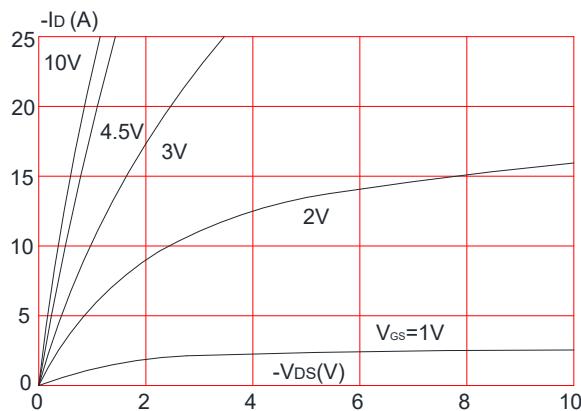
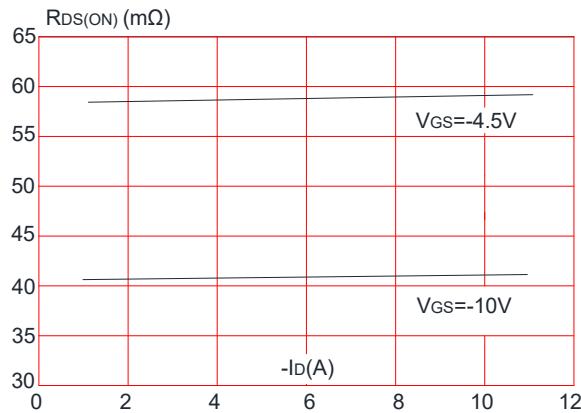
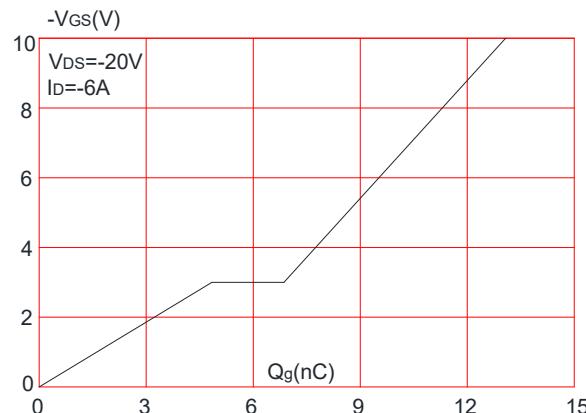
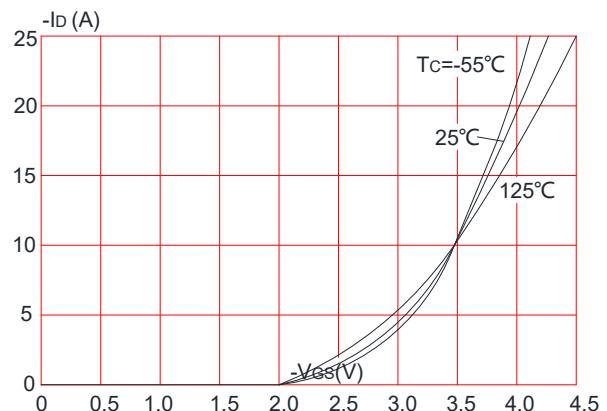
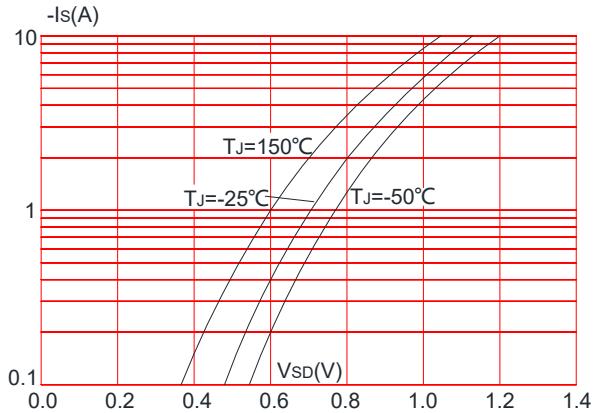
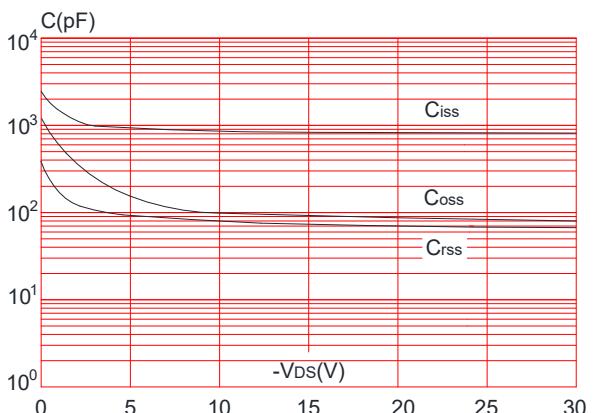


**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



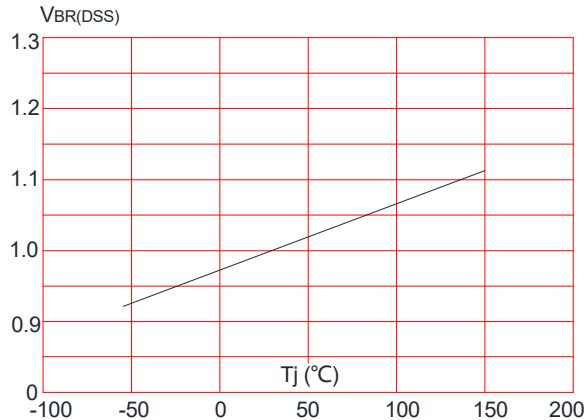
## N-Ch and P-Ch Fast Switching MOSFETs

## Typical Performance Characteristics-P

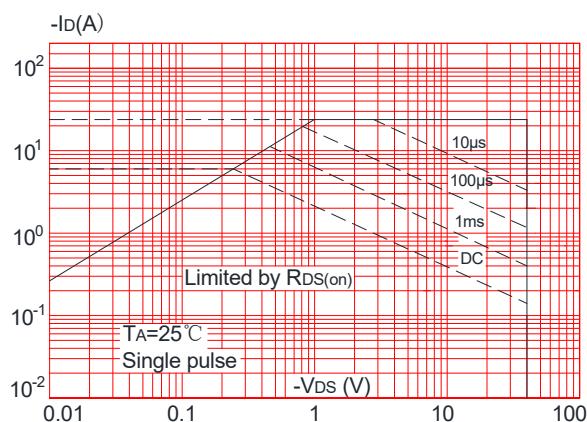
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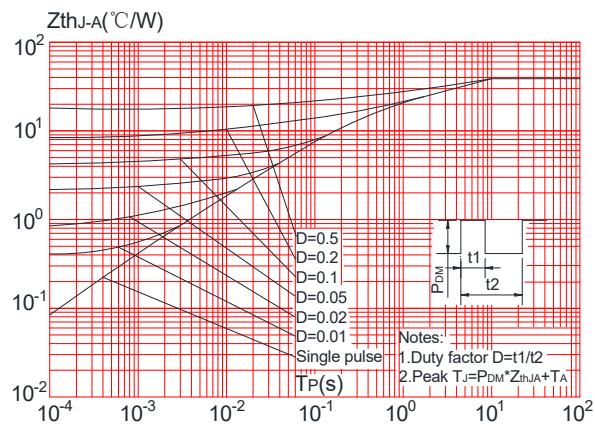
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



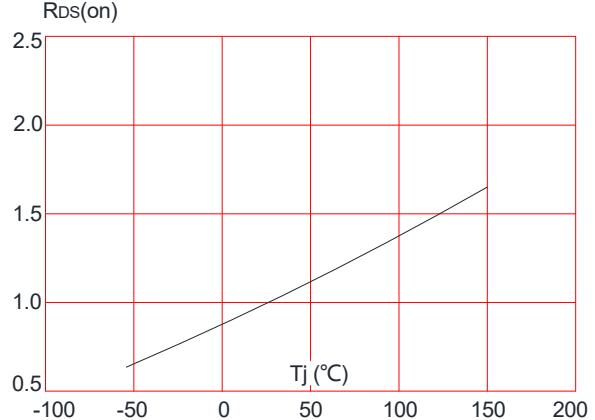
**Figure 9:** Maximum Safe Operating Area



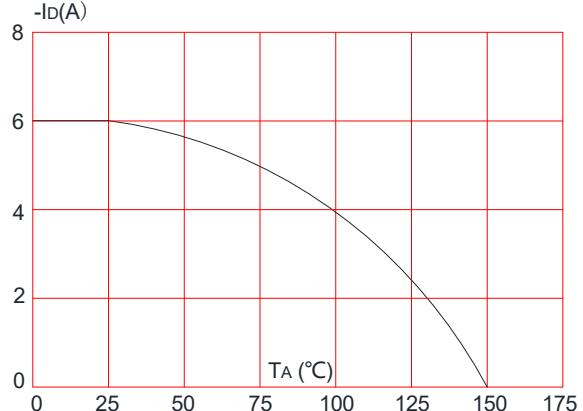
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**Figure 8:** Normalized on Resistance vs. Junction Temperature

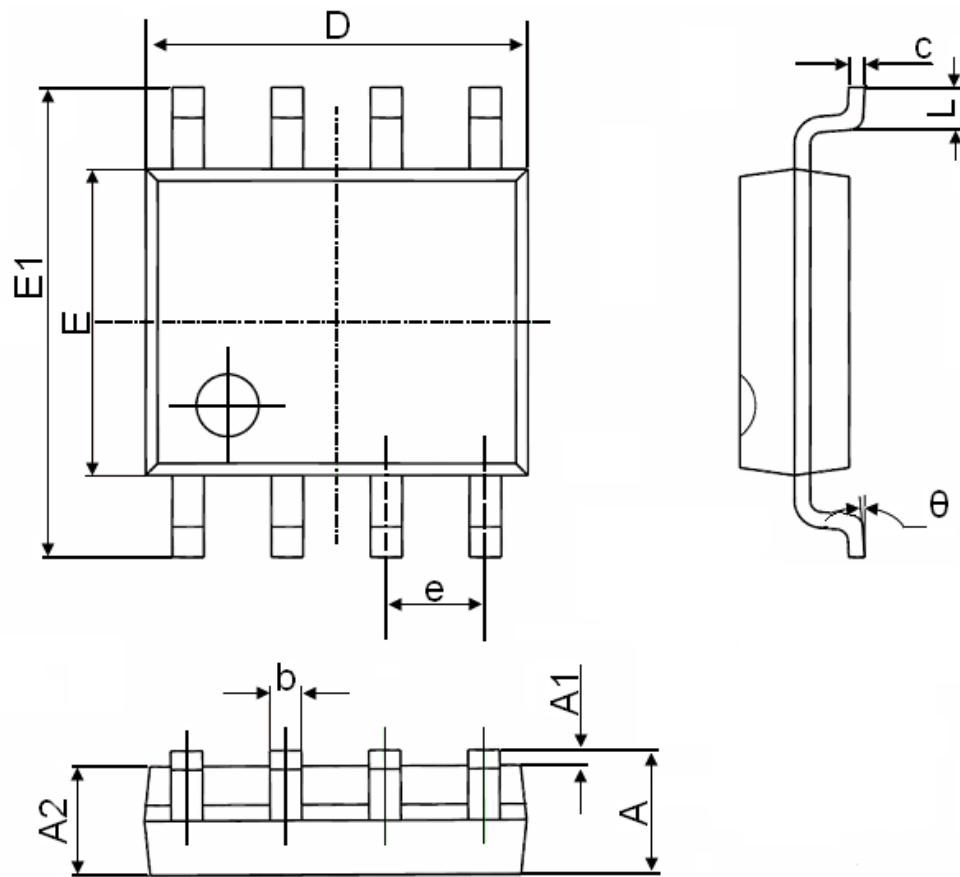


**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



## N-Ch and P-Ch Fast Switching MOSFETs

## Package Mechanical Data- SOP-8



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1     | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2     | 1.350                     | 1.550 | 0.053                | 0.061 |
| b      | 0.330                     | 0.510 | 0.013                | 0.020 |
| c      | 0.170                     | 0.250 | 0.006                | 0.010 |
| D      | 4.700                     | 5.100 | 0.185                | 0.200 |
| E      | 3.800                     | 4.000 | 0.150                | 0.157 |
| E1     | 5.800                     | 6.200 | 0.228                | 0.244 |
| e      | 1.270(BSC)                |       | 0.050(BSC)           |       |
| L      | 0.400                     | 1.270 | 0.016                | 0.050 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |
| A      |                           |       |                      |       |